

# **Film Capacitors**

# Metallized Polypropylene Film Capacitors (MKP)

 Series/Type:
 B32774P ... B32778P

 Date:
 February 2017

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Metallized polypropylene film capacitors (MKP)

## MKP DC Link - 125 $^\circ C$ series up to 50 $\mu F$

B32774P ... B32778P

# **Typical applications**

- Frequency converters
- Industrial and high-end power supplies
- Automotive DC-DC and Compressor

#### Climatic

- Max. operating temperature: 125 °C (case)
- Climatic category (IEC 60068-1): 40/110/56

#### Construction

- Dielectric: Polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

#### Features

- Capacitance value up to 50 µF
- Good self-healing properties
- Over-voltage capability
- Low losses with high current capability
- High reliability
- RoHS-compatible

#### Terminals

- Parallel wire leads, lead-free tinned
- 2-pin and 4-pin
- Standard lead lengths: 6 –1 mm

#### Marking

Manufacturer's logo and lot number, date code, rated capacitance (coded), capacitance tolerance (code letter), rated DC voltage

# **Delivery mode**

Bulk (untaped, lead length 6 - 1 mm)



B32774P ... B32778P

MKP DC Link - 125  $^{\circ}\text{C}$  series up to 50  $\mu\text{F}$ 

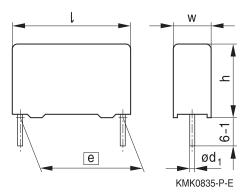
# **Dimensional drawings**

Number of wires	Lead spacing e ±0.4	Lead diameter $d_1 \pm 0.05$	Туре
2-pin	27.5	1.01)	B32774P
2-pin	37.5	1.0	B32776P
2-pin	37.5	1.01)	B32776P
4-pin	37.5	1.21)	B32776P
4-pin	52.5	1.21)	B32778P

Dimensions in mm

# **Dimensional drawings 2-pin versions**

# B32774P, B32776P

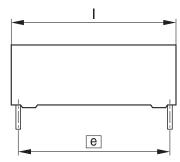


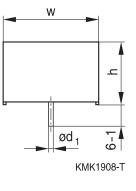


	B32774P	B32776P
Lead spacing $\boxed{e} \pm 0.4$ :	27.5	37.5
Lead diameter d <sub>1</sub> :	<b>1.0</b> <sup>1)</sup>	1.0
		D' ' '

Dimensions in mm

#### B32776P







Lead spacing $\boxed{e} \pm 0.4$ :	37.5
Lead diameter d <sub>1</sub> :	1.0 <sup>1)</sup>

1) Reinforced for vibration

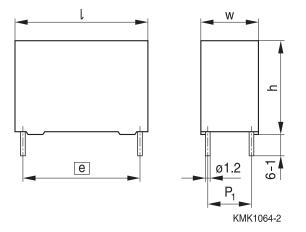
Dimensions in mm





Dimensional drawings 4-pin versions

# B32776P, B32778P





	B32776P	B32778P
Lead spacing $\boxed{e} \pm 0.4$ :	37.5	52.5
Lead diameter d <sub>1</sub> :	1.2 <sup>2)</sup>	1.2 <sup>2)</sup>

Dimensions in mm

2) Reinforced for vibration



B32774P ... B32778P

MKP DC Link - 125  $^\circ C$  series up to 50  $\mu F$ 

# Overview of available types

Lead spacing	27.5 mr	n		37.5 mn	n		52.5 mm	า	
Туре	B32774			B32776	Р		B32778	Р	
Page	6	6 7 8							
V <sub>R</sub> (V DC)	630	700	840	630	700	840	630	700	840
C <sub>R</sub> (μF)									
1.0									
1.5									
2.0									
2.2									
2.7									
3.0									
3.3									
3.5									
3.9									
4.7									
5.0									
6.8									
7.0									
7.5									
8.0									
10									
12									
14									
15									
16									
20									
22									
25									
27									
30									
35									
40									
50									



B32774P

MKP DC Link - 125  $^\circ C$  series up to 50  $\mu F$ 

# Ordering codes and packing units (lead spacing 27.5 mm)

$C_R^{1)}$	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS,max</sub> <sup>2)</sup>	<b>ESR</b> <sub>typ</sub>	ESL <sub>typ</sub> <sup>3)</sup>	$tan \delta$	tan δ	MOQ
	$w \times h \times l$		(composition see	85 °C			max.	max.	
			below)	10 kHz	10 kHz		1 kHz	10 kHz	
μF	mm	mm		А	mΩ	nH	10 <sup>-3</sup>	10 <sup>-3</sup>	pcs.
$V_{R,85}$	° <sub>C</sub> = 630 V DC	1		1				1	
1.5	$11.0\times19.0\times31.5$	_	B32774P6155+000	3.5	22.3	13.2	0.5	3.5	1280
2.2	$12.5 \times 21.5 \times 31.5$	_	B32774P6225+000	4.7	15.5	14.5	0.5	3.5	1120
3.0	$14.0\times24.5\times31.5$	_	B32774P6305+000	6.0	11.5	16.1	0.5	3.5	1040
4.7	$18.0\times27.5\times31.5$	_	B32774P6475+000	8.2	7.6	18.7	0.5	3.7	800
6.8	$21.0 \times 31.0 \times 31.5$	_	B32774P6685+000	10.4	5.4	21.3	0.6	3.9	720
8.0	$22.0\times36.5\times31.5$	_	B32774P6805+000	12.0	4.5	24.0	0.6	4.0	640
$V_{R,85}$	° <sub>C</sub> = 700 V DC								
1.5	$11.0\times19.0\times31.5$	_	B32774P7155+000	3.6	20.3	18.4	0.5	3.2	1280
2.0	$12.5 \times 21.5 \times 31.5$	_	B32774P7205+000	4.7	15.3	19.8	0.5	3.2	1120
3.3	$18.0\times27.5\times31.5$	_	B32774P7335+000	7.3	9.6	22.9	0.5	3.3	800
4.7	$19.0\times30.0\times31.5$	_	B32774P7475+000	9.0	6.9	25.8	0.5	3.4	720
7.0	$22.0\times36.5\times31.5$	_	B32774P7705+000	11.8	5.0	31.2	0.5	3.7	640
$V_{R,85}$	° <sub>C</sub> = 840 V DC								
1.0	$11.0 \times 19.0 \times 31.5$	_	B32774P8105+000	3.3	25.2	18.3	0.5	2.7	1280
1.5	$12.5 \times 21.5 \times 31.5$	_	B32774P8155+000	4.4	17.2	20.2	0.5	2.7	1120
3.0	$18.0 \times 27.5 \times 31.5$	_	B32774P8305+000	7.5	9.1	25.6	0.5	2.8	800
5.0	$22.0\times36.5\times31.5$	—	B32774P8505+000	12.5	5.8	31.6	0.5	3.0	640

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

Packing code: 000 = untaped (lead length 6 – 1 mm) Other lead lengths available upon request

 $\begin{array}{l} \mathsf{K}=\pm10\%\\ \mathsf{J}=\pm5\% \end{array}$ 

1) Capacitance value measured at 1 kHz

2) Max. ripple current I\_{RMS} at 85 °C at 10 kHz for a  $\Delta T \leq$  15 °C when  $\Delta ESR_{typ} \leq \pm 5\%$ 

3) ESL value measured at resonance frequency (see specific graphs of Z vs freq)



MKP → 37.5 →

**B32776P** 

# MKP DC Link - 125 °C series up to 50 $\mu$ F

#### Ordering codes and packing units (lead spacing 37.5 mm)

$\overline{C_{R}^{1)}}$	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS,max</sub> 2)	ESR	ESL <sub>typ</sub> <sup>3)</sup>	tan δ	tan δ	MOQ
	w×h×l		(composition see	85 °C	ψp	цр	max.	max.	
			below)	10 kHz	10 kHz		1 kHz	10 kHz	
μF	mm	mm	· · · · /	A	mΩ	nH	10 <sup>-3</sup>	10 <sup>-3</sup>	pcs.
$V_{R,85}$	<sub>°c</sub> = 630 V DC	<u>.                                    </u>		1	I		I	II	
5.0	$24.0 \times 15.0 \times 42.0$	_	B32776P6505+000	6.0	13.4	19.4	0.9	6.9	1040
7.5	$24.0 \times 19.0 \times 42.0$	_	B32776P6755K000	7.6	9.5	19.6	0.9	6.9	780
10.0	$18.0 \times 32.5 \times 42.0$	_	B32776P6106K000	9.6	7.0	23.4	0.9	7.2	720
15.0	$20.0\times39.5\times42.0$	10.2	B32776P6156K000	13.0	4.8	12.4	0.9	7.1	640
20.0	$28.0\times37.0\times42.0$	10.2	B32776P6206K000	16.0	3.6	11.5	0.9	7.1	440
22.0	$28.0\times42.5\times42.0$	10.2	B32776P6226K000	17.5	3.2	13.2	0.9	7.3	440
25.0	$30.0\times45.0\times42.0$	20.3	B32776P6256+000	19.5	2.9	13.9	0.9	7.4	400
30.0	$33.0\times48.0\times42.0$	20.3	B32776P6306+000	22.5	2.4	15.1	0.9	7.6	180
$V_{R,85}$	° <sub>C</sub> = 700 V DC								
3.9	$24.0 \times 15.0 \times 42.0$	_	B32776P7395+000	5.6	15.3	19.2	0.8	6.2	1040
5.0	$24.0\times19.0\times42.0$	_	B32776P7505+000	6.8	12.1	19.1	0.8	6.3	780
12.0	$20.0\times39.5\times42.0$	10.2	B32776P7126K000	12.5	5.3	12.4	0.8	6.4	640
14.0	$28.0\times37.0\times42.0$	10.2	B32776P7146+000	14.5	4.4	11.3	0.8	6.4	440
16.0	$28.0\times42.5\times42.0$	10.2	B32776P7166+000	16.0	3.9	12.5	0.8	6.5	440
20.0	$30.0\times45.0\times42.0$	20.3	B32776P7206+000	19.0	3.2	13.5	0.8	6.6	400
22.0	$33.0\times48.0\times42.0$	20.3	B32776P7226+000	20.5	2.9	14.2	0.9	6.7	180
$V_{R,85}$	° <sub>C</sub> = 840 V DC								
2.7	$24.0\times15.0\times42.0$	-	B32776P8275+000	5.2	18.6	19.2	0.7	5.2	1040
3.5	$24.0\times19.0\times42.0$	_	B32776P8355+000	6.2	14.3	19.2	0.7	5.2	780
8.0	$20.0\times39.5\times42.0$	10.2	B32776P8805+000	11.0	6.3	12.4	0.7	5.3	640
10.0	$28.0\times37.0\times42.0$	10.2	B32776P8106+000	13.5	5.1	11.5	0.7	5.3	440
12.0	$28.0\times42.5\times42.0$	10.2	B32776P8126+000	15.0	4.4	12.8	0.7	5.4	440
14.0	$30.0\times45.0\times42.0$	20.3	B32776P8146+000	17.0	3.8	13.7	0.7	5.5	400
16.0	$33.0\times48.0\times42.0$	20.3	B32776P8166+000	19.0	3.3	14.5	0.7	5.5	180

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

- $K = \pm 10\%$
- $J = \pm 5\%$

Packing code: 000 = untaped (lead length 6 – 1 mm) Other lead lengths available upon request

- 1) Capacitance value measured at 1 kHz
- 2) Max. ripple current I\_{RMS} at 85 °C at 10 kHz for a  $\Delta T \leq$  15 °C when  $\Delta ESR_{typ} \leq \pm 5\%$
- 3) ESL value measured at resonance frequency (see specific graphs of Z vs freq)





B32778P

MKP DC Link - 125  $^\circ\text{C}$  series up to 50  $\mu\text{F}$ 

#### Ordering codes and packing units (lead spacing 52.5 mm)

$C_R^{(1)}$	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS,max</sub> 2)	<b>ESR</b> <sub>typ</sub>	ESL <sub>typ</sub> <sup>3)</sup>	tan δ	tan δ	MOQ
	$w \times h \times I$		(composition see	85 °C			max.	max.	
			below)	10 kHz	10 kHz		1 kHz	10 kHz	
μF	mm	mm		А	mΩ	nH	10 <sup>-3</sup>	10 <sup>-3</sup>	pcs.
V <sub>R,85</sub> °c	c = 630 V DC								
35.0	$30.0\times45.0\times57.5$	20.3	B32778P6356+000	18.5	4.0	13.9	1.6	14.3	280
50.0	$35.0\times50.0\times57.5$	20.3	B32778P6506K000	23.5	2.9	16.0	1.6	14.8	108
V <sub>R,85</sub> °c	c = 700 V DC								
30.0	$30.0\times45.0\times57.5$	20.3	B32778P7306+000	18.5	4.2	14.2	1.5	12.9	280
40.0	$35.0\times50.0\times57.5$	20.3	B32778P7406+000	22.5	3.2	15.9	1.5	13.2	108
V <sub>R,85</sub> °c	c = 840 V DC								
20.0	$30.0\times45.0\times57.5$	20.3	B32778P8206+000	16.5	5.1	14.0	1.2	10.6	280
27.0	$35.0\times50.0\times57.5$	20.3	B32778P8276+000	20.5	3.9	15.7	1.3	10.8	108

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

#### Composition of ordering code

+ = Capacitance tolerance code:

Packing code:

 $K = \pm 10\%$ 

 $J = \pm 5\%$ 

000 = untaped (lead length 6 – 1 mm) Other lead lengths available upon request

- 1) Capacitance value measured at 1 kHz
- 2) Max. ripple current I\_{RMS} at 85 °C at 10 kHz for a  $\Delta T \leq$  15 °C when  $\Delta ESR_{typ} \leq \pm 5\%$
- 3) ESL value measured at resonance frequency (see specific graphs of Z vs freq)



B32774P ... B32778P

MKP DC Link - 125  $^\circ C$  series up to 50  $\mu F$ 

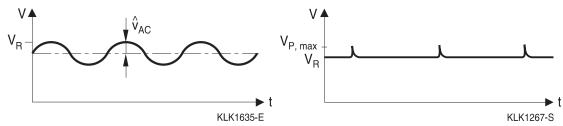
## **Technical data**

Reference standard: IEC 60384-16 and AEC-Q200. All data given at T = 20  $^{\circ}$ C, unless otherwise specified.

Operating temperatur	re range (case)	Max. o	perating tem	perature, T <sub>op,max</sub> +1	25 °C <sup>1)</sup>	
	0 ( )	Upper of	category tem	perature T <sub>max</sub>	+110 °C	
		Lower	category terr	nperature T <sub>min</sub>	−40 °C	
Insulation Resistance	e R <sub>ins</sub> given as time	τ > 100	00 s (after 1	min) at 500 V DO	)	
constant $\tau = C_R \cdot R_{ins}$	, rel. humidity $\leq 65\%$					
(minimum as-delivere	ed values)					
DC voltage test betwe	een terminals (10 s)	1.5 · V	R			
Voltage test terminal	to case (10 s)	2110 V AC, 50 Hz				
Peak current I <sub>P</sub> (A)		C (μF)	· dV/dt			
Reliability:	Failure rate $\lambda$	5 fit (≤	1 · 10⁻º h) at	0.5 · V <sub>R</sub> , 40 °C		
	Service life t <sub>SL</sub>	40 000	h at V <sub>R</sub> , 85 $^{\circ}$	O		
		For cor	nversion to o	ther operating co	nditions and	
		temper	atures, refer	to chapter		
		"Quality	y, 2 Reliabilit	'Y".		
	$V_{R}$ (V DC) at 85 °C <sup>1)</sup>	630	700	840		
Continuous operation	voltage $V_{op}$ at 105 °C <sup>1)</sup>	540	600	720		
Continuous operation	h voltage $V_{op}$ at 125 °C <sup>1)</sup>	450	500	600		
For temperatures bet	ween 85 °C and 125 °C <sup>1)</sup>	0.7%/°0	C of V <sub>op</sub> de-ra	ating compared to	o V₀₀ at 85 °C	

1) Temperatures given as operating temperature T<sub>op</sub> (ambient temperature + self-heating), for example when ambient temperature is 125 °C, selfheating is 0 °C, or ripple current cannot be permitted.

#### **Typical waveforms**



**Restrictions:** 

 $V_{R}$ : Maximum operating peak voltage of either polarity but of a non-reversing waveform, for which the capacitor has been designed for continuous operation.

 $\boldsymbol{\hat{u}}_{\text{AC}} \! \leq \! \boldsymbol{0.2} \, \cdot \, \boldsymbol{V}_{\text{R}}$ 

 $V_{p, max}$ :

Overvoltage	Maximum duration within one day
1.1 · V <sub>R</sub>	30% of on-load duration
1.15 · V <sub>B</sub>	30 min.
1.2 · V <sub>R</sub>	5 min.
1.3 · V <sub>R</sub>	1 min.





## Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/ $\mu$ s.

Note:

The values of dV/dt and  $k_0$  provided below must not be exceeded in order to avoid damaging the capacitor. These parameters are given for isolated pulses in such a way that the heat generated by one pulse will be completely dissipated before applying the next pulse. For a train of pulses, please refer to the curves of permissible AC voltage-current versus frequency.

#### dV/dt values

Lead spacing	27.5 mm	า		37.5 mm	n		52.5 mn	n	
Туре	B32774	Ρ		B32776	Р		B32778	Р	
V <sub>R</sub> (V DC)	630	700	840	630	700	840	630	700	840
dV/dt in V/µs	50	75	100	35	54	73	25	35	50



B32774P ... B32778P

MKP DC Link - 125 °C series up to 50  $\mu$ F

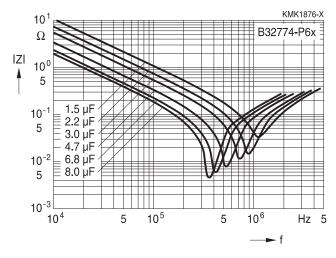
#### **Characteristics curves**

Additional technical information can be found under "Design support" on www.epcos.com.

# Impedance Z versus frequency f

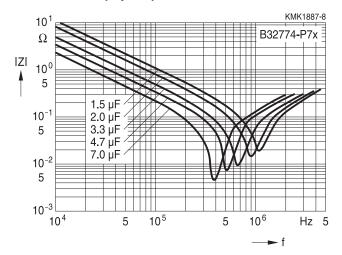
(typical values)

# Lead spacing 27.5 mm B32774-P6x (2 pins) / 630 V DC



#### Impedance Z versus frequency f (typical values)

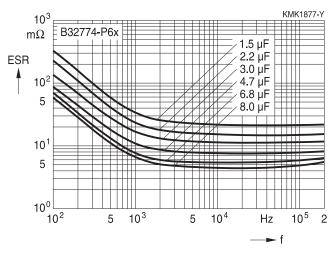
#### Lead spacing 27.5 mm B32774-P7x (2 pins) / 700 V DC



#### ESR versus frequency f

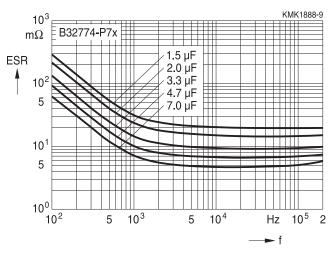
(typical values)

# Lead spacing 27.5 mm B32774-P6x (2 pins) / 630 V DC



ESR versus frequency f (typical values)

#### Lead spacing 27.5 mm B32774-P7x (2 pins) / 700 V DC



Please read *Cautions and warnings* and *Important notes* at the end of this document.



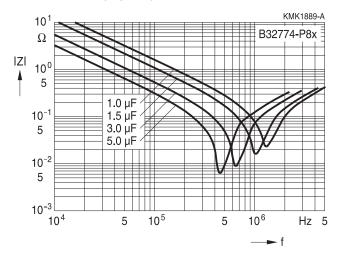


MKP DC Link - 125 °C series up to 50  $\mu$ F

#### **Characteristics curves**

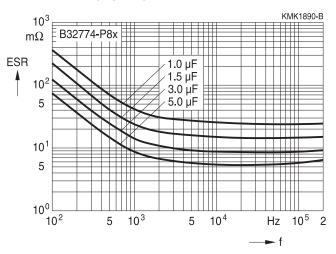
Impedance Z versus frequency f (typical values)

# Lead spacing 27.5 mm B32774-P8x (2 pins) / 840 V DC



ESR versus frequency f (typical values)

Lead spacing 27.5 mm B32774-P8x (2 pins) / 840 V DC





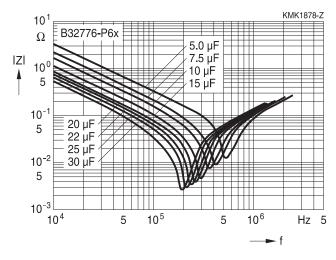
B32774P ... B32778P

MKP DC Link - 125 °C series up to 50  $\mu$ F

# **Characteristics curves**

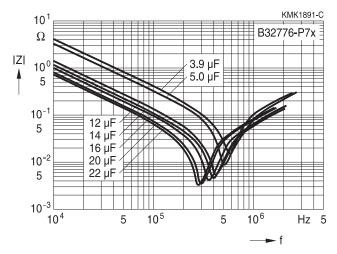
Impedance Z versus frequency f (typical values)

# Lead spacing 37.5 mm B32776-P6x (2/4 pins) / 630 V DC



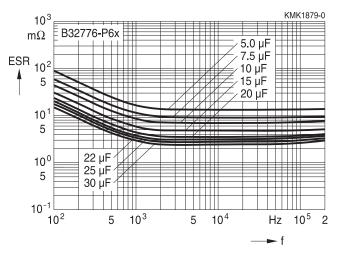
Impedance Z versus frequency f (typical values)

# Lead spacing 37.5 mm B32776-P7x (2 pins, 4 pins) / 700 V DC



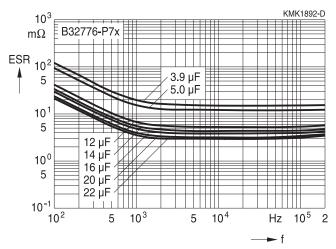
ESR versus frequency f (typical values)

Lead spacing 37.5 mm B32776-P6x (2/4 pins) / 630 V DC



ESR versus frequency f (typical values)

# Lead spacing 37.5 mm B32776-P7x (2 pins, 4 pins) / 700 V DC



Please read *Cautions and warnings* and *Important notes* at the end of this document.



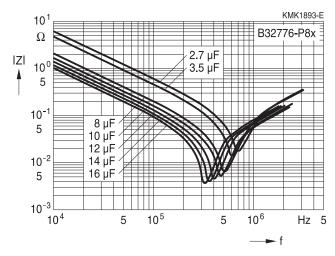


MKP DC Link - 125 °C series up to 50  $\mu$ F

#### **Characteristics curves**

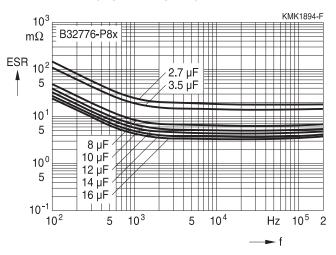
Impedance Z versus frequency f (typical values)

Lead spacing 37.5 mm B32776-P8x (2 pins, 4 pins) / 840 V DC



ESR versus frequency f (typical values)

Lead spacing 37.5 mm B32776-P8x (2 pins, 4 pins) / 840 V DC





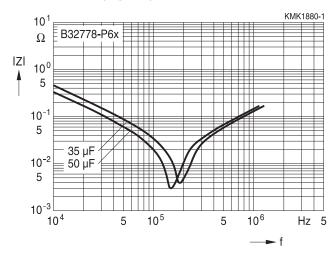
B32774P ... B32778P

MKP DC Link - 125 °C series up to 50  $\mu$ F

#### **Characteristics curves**

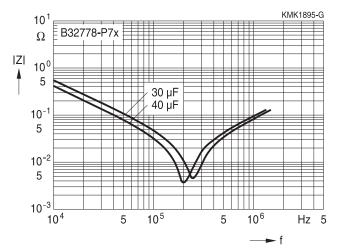
Impedance Z versus frequency f (typical values)

# Lead spacing 52.5 mm B32778-P6x (4 pins) / 630 V DC



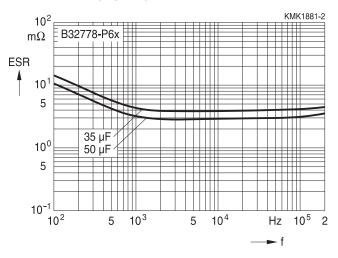
Impedance Z versus frequency f (typical values)

# Lead spacing 52.5 mm B32778-P7x (4 pins) / 700 V DC



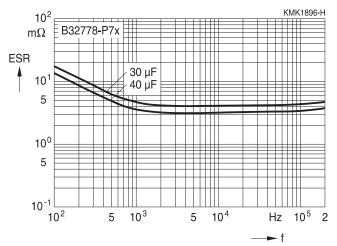
# ESR versus frequency f (typical values)

Lead spacing 52.5 mm B32778-P6x (4 pins) / 630 V DC



ESR versus frequency f (typical values)

# Lead spacing 52.5 mm B32778-P7x (4 pins) / 700 V DC





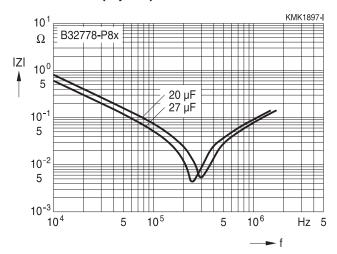


MKP DC Link - 125 °C series up to 50  $\mu$ F

## **Characteristics curves**

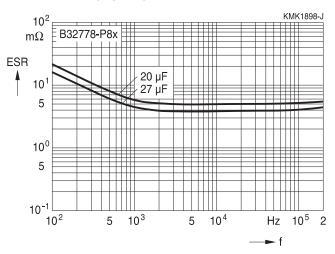
Impedance Z versus frequency f (typical values)

# Lead spacing 52.5 mm B32778-P8x (4 pins) / 840 V DC



ESR versus frequency f (typical values)

Lead spacing 52.5 mm B32778-P8x (4 pins) / 840 V DC





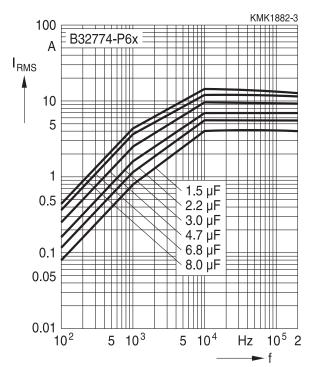
B32774P ... B32778P

MKP DC Link - 125  $^{\circ}\text{C}$  series up to 50  $\mu\text{F}$ 

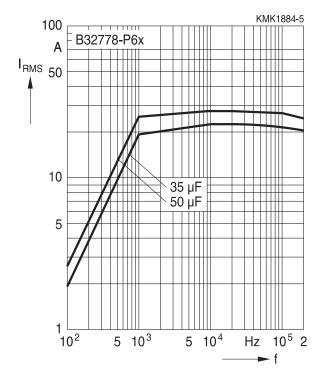
#### **Characteristics curves**

Permissible current I<sub>RMS</sub> versus frequency f (for sinusoidal waveforms,  $T_A \le 85 \text{ }^{\circ}C$ ) For  $T_A > 85 \text{ }^{\circ}C$ , please use derating factor  $F_T$ .

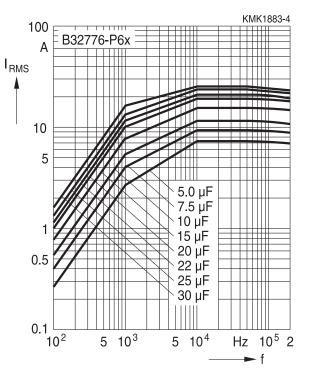
# Lead spacing 27.5 mm B32774-P6x (2 pins) / 630 V DC



# Lead spacing 52.5 mm B32778-P6x (4 pins) / 630 V DC



# Lead spacing 37.5 mm B32776-P6x (2/4 pins) / 630 V DC



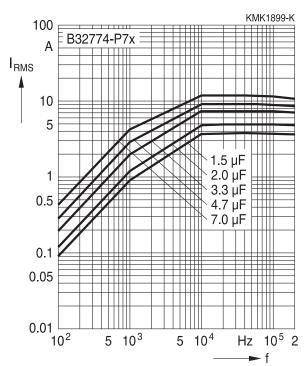




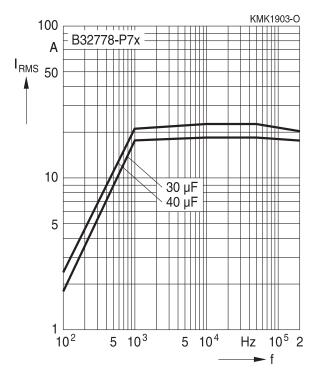
#### **Characteristics curves**

Permissible current  $I_{RMS}$  versus frequency f (for sinusoidal waveforms,  $T_A \le 85 \text{ }^{\circ}C$ ) For  $T_A > 85 \text{ }^{\circ}C$ , please use derating factor  $F_T$ .

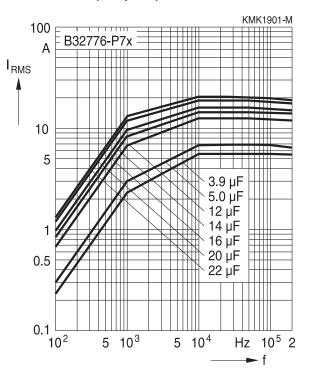
# Lead spacing 27.5 mm B32774-P7x (2 pins) / 700 V DC



# Lead spacing 52.5 mm B32778-P7x (4 pins) / 700 V DC



# Lead spacing 37.5 mm B32776-P7x (2/4 pins) / 700 V DC



Please read *Cautions and warnings* and *Important notes* at the end of this document.



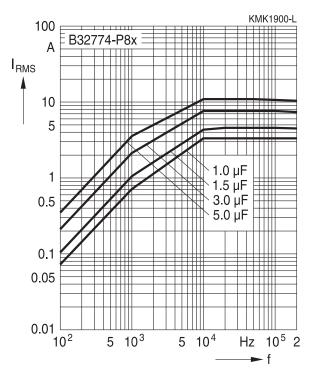
B32774P ... B32778P

MKP DC Link - 125  $^\circ\text{C}$  series up to 50  $\mu\text{F}$ 

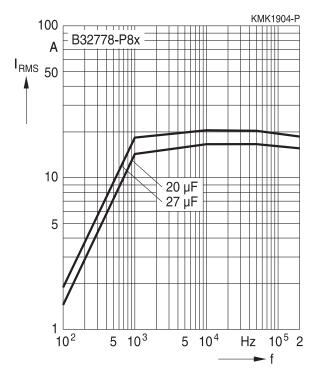
#### **Characteristics curves**

Permissible current I<sub>RMS</sub> versus frequency f (for sinusoidal waveforms,  $T_A \le 85 \text{ }^{\circ}C$ ) For  $T_A > 85 \text{ }^{\circ}C$ , please use derating factor  $F_T$ .

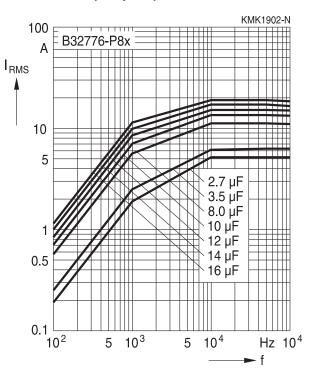
# Lead spacing 27.5 mm B32774-P8x (2 pins) / 840 V DC



# Lead spacing 52.5 mm B32778-P8x (4 pins) / 840 V DC



# Lead spacing 37.5 mm B32776-P8x (2/4 pins) / 840 V DC

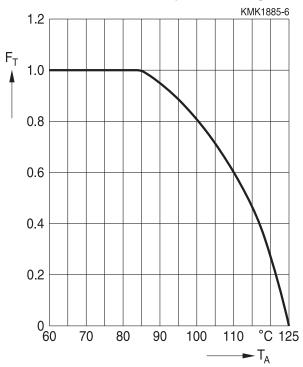


Please read *Cautions and warnings* and *Important notes* at the end of this document.





Curves Characteristics (I $_{\mbox{\tiny RMS}}$  derating vs temperature)



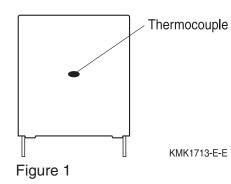
Maximum  $I_{RMS}$  current as function of the ambient temperature:  $I_{RMS}$  (T<sub>A</sub>) = F<sub>T</sub> ×  $I_{RMS}$  (85 °C)



# B32774P ... B32778P

MKP DC Link - 125  $^\circ C$  series up to 50  $\mu F$ 

# Heat transference for self heating calculation



Box dime	ensions	Equivalent heat coefficient	
w (mm)	h (mm)	l (mm)	G (mW/°C)
11.0	19.0	31.5	25
11.0	21.0	31.5	28
12.5	21.5	31.5	30
13.5	23.0	31.5	32
14.0	24.5	31.5	35
15.0	24.5	31.5	36
16.0	32.0	31.5	45
18.0	27.5	31.5	44
18.0	33.0	31.5	48
19.0	30.0	31.5	48
21.0	31.0	31.5	51
22.0	36.5	31.5	58
12.0	22.0	42.0	70
14.0	25.0	42.0	43
16.0	28.5	42.0	50
18.0	32.5	42.0	59
20.0	39.5	42.0	72
24.0	19.0	42.0	50
24.0	15.0	42.0	44
28.0	37.0	42.0	83
28.0	42.5	42.0	90
30.0	45.0	42.0	100
33.0	48.0	42.0	110
30.0	45.0	57.5	125
35.0	50.0	57.5	145

The equivalent heat coefficient "**G** (**mW**/<sup>o</sup>**C**)" is given for measuring the temperature on the lateral surface of the plastic box as figure1 shows. By using a thermocouple and avoiding effect of radiation and convection the temperature measured during operation conditions should be a result of the dissipated power divided by the equivalent heat coefficient.

Please read *Cautions and warnings* and *Important notes* at the end of this document.





MKP DC Link – 125 °C series up to 50 µF

# Self Heating by power dissipation and equivalent heat coefficient

The  $I_{RMS}$  and consequently the power dissipation must be limited during operation in order to not exceed the maximum limit of  $\Delta T$  allowed for this series.  $\Delta T_{max}$  given for this series is equal or lower than 15 °C at rated temperature (85 °C), for higher ambient temperatures  $\Delta T_{max}$  (T) will have the same derating factor than  $I_{RMS}$  vs temperature and then an equivalent derating as per:

 $\Delta T_{max}$  (T) = (Factor)<sup>2</sup> ×  $\Delta T$  (85 °C).

For any particular  $I_{\text{RMS}}$  the  $\Delta T$  may be calculated by:

 $\Delta T (^{\circ}C) = P_{dis} (mW) / G(mW/^{\circ}C).$ 

Where  $\Delta T$  (°C) is the difference between the temperature measured on the box (see figure 1) and the ambient temperature when capacitor is working during normal operation;

$$\Delta T (^{\circ}C) = T_{op}(^{\circ}C) - T_{A} (^{\circ}C).$$

It represents the increasing of temperature provoked by the  $I_{\text{RMS}}$  during operation.

G (mW/°C) is the equivalent heat coefficient described above and  $P_{dis}$  (mW) is the dissipated power defined by:  $P_{dis}$  (mW) = ESR<sub>typ</sub> (m $\Omega$ ) ×  $I_{RMS}^2$  ( $A_{RMS}$ ).

#### Example for thermal calculation:

We will take as reference B32778P6506K (50  $\mu$ F/630 V DC) type for thermal calculation. Considering the following load and capacitor characteristics:

 $I_{RMS}$ : 15  $A_{RMS}$  at 20 kHz  $T_A$ : 100 <sup>o</sup>C 35 × 50 × 57.5 box G (mW/<sup>o</sup>C): 145

Then we have to find the ESR<sub>typ</sub> at 20 kHz what is approximately 2.9 m $\Omega$ .

So according to	$P_{dis} (mW) = ESR_{typ} (m\Omega) \times I_{RMS}  {}^2 (A_{RMS})$
we have the following:	$P_{dis} (mW) = 2.9 m\Omega \times 10 A_{RMS}^2 = 290 mW.$
And as per	$\Delta T (^{\circ}C) = P_{dis} (mW) / G (mW/^{\circ}C)$
we have the following:	∆T (°C) = 290 (mW) / 145 (mW/°C) = 4.5 °C.
What is below of the	$\Delta T_{max}$ (100 °C) = (Factor) <sup>2</sup> × $\Delta T$ (85 °C) = (0.80) <sup>2</sup> × 15 °C = 9.6 °C.

On the other hand we may confirm that max  $I_{RMS}$  at 20 kHz at 85 °C = 23.5  $A_{RMS}$ .

And then max I<sub>RMS</sub> for 85 °C of ambient temperature is defined as follows:

 $I_{RMS}$  (100 °C) = Factor ×  $I_{RMS}$  (85 °C) = 0.80 × 23.5  $A_{RMS}$  = 18.8  $A_{RMS}$ .

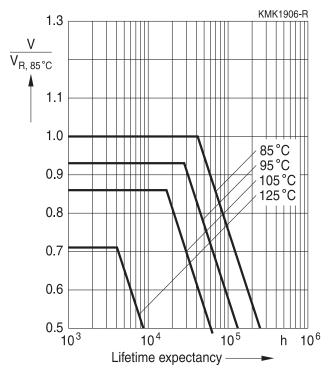
What confirms once again that  $I_{RMS}$  (10  $A_{RMS}$  at 20 kHz at 100 °C) is below the max specified for such frequency and ambient temperature.





MKP DC Link - 125  $^\circ C$  series up to 50  $\mu F$ 

# Service life Life time expectancy - typical curve



Note:

(1) Confidence level of 98%

(2) Life expectancy is given as a function of operating temperature (capacitor body temperature).



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MKP DC Link - 125  $^\circ C$  series up to 50  $\mu F$ 

# **Testing and Standards**

Test	Reference	Conditions of test		Performance requirements
Electrical Parameters (Routine test)	IEC 61071-11	Voltage between terminals, 1.5 V <sub>R</sub> , during 10 s Insulation resistance, R <sub>INS</sub> at 500 V Capacitance, C at 1 kHz (room temperature) Dissipation factor, tan $\delta$ at 1/10 kHz (room temperature)		Within specified limits
Robustness of termina- tions (Type test)	IEC 60068-2-21	Tensile strength (test Ua Wire diameter $0.5 < d_1 \le 0.8 \text{ mm}$ $0.8 < d_1 \le 1.25 \text{ mm}$	1) Tensile force 10 N 20 N	Capacitance and tan $\delta$ within specified limits
Resistance to solder- ing heat (Type test)	IEC 60068-2-20, test Tb, method 1A	Solder bath temperature at 260 $\pm$ 5 °C, immersion for 10 seconds		$ \Delta C/C_0  \le 2\%$ $ \Delta \tan \delta  \le 0.002$
Bump (Type test)	IEC 60384-16	Test Eb: Total 4000 bumps with 390 m/s <sup>2</sup> mounted on PCB 6 ms duration		No visible damage $ \Delta C/C_0  \le 2\%$ $ \Delta \tan \delta  \le 0.002$ $R_{INS} \ge 50\%$ of initial limit
Climatic sequence (Type test)	IEC 60384-16	Dry heat Tb / 16 h. Damp heat cyclic, 1st cycle + 55 °C / 24h / 95% 100% RH Cold Ta / 2h Damp heat cyclic, 5 cycles + 55 °C / 24h / 95% 100% RH		No visible damage $ \Delta C/C_0  \le 3\%$ $ \Delta \tan \delta  \le 0.001$ $R_{INS} \ge 50\%$ of initial limit
Thermal shock	AEC-Q200	−55 °C +85 ºC, 1000 cycles		No visible damage $ \Delta C/C0  \le 2\%$ $ \Delta \tan \delta  \le 0.002 (1 \text{kHz})$ $R_{\text{INS}} \ge 50\%$ of initial limit
Vibration	AEC-Q200	5 <i>g</i> for 20 minutes, 12 cycles, each of 3 orientations (X, Y, Z axis), 240 min/axis, total 12 hours Test from 10-2000 Hz		No visible damage



MKP DC Link - 125  $^\circ\text{C}$  series up to 50  $\mu\text{F}$ 

MKP				

Test	Reference	Conditions of test	Performance requirements
High tem- perature high humi- dity with	AEC-Q200	40 °C/93% RH/1000 hours with V <sub>R</sub> 60 °C/95% RH/500 hours with V <sub>R</sub>	No visible damage $ \Delta C/C_0  \le 5\%$ $ \Delta \tan \delta/\tan \delta  \le 400\%$ (1kHz) $R_{INS} \ge 50\%$ of initial limit
load		$V_{R} = 630$ : 85 °C/85% RH/1000 hours with 450 V DC $V_{R} = 700$ : 85 °C/85% RH/1000 hours with 500 V DC	$ \Delta C/C_0  \le 5\%$ $ \Delta \tan \delta  \le 0.005 (1kHz)$ $R_{INS} \ge 50\%$ of initial limit
		V <sub>R</sub> = 840: 85 °C/85% RH/1000 hours with 600 V DC	
Endurance (Type test)	IEC 60384-16	85 °C/1.25 $V_{P}$ /1000 hours or 105 °C/1.25 $V_{op}$ /1000 hours or 125 °C/1.25 $V_{op}$ /1000 hours	No visible damage $ \Delta C/C_0  \le 5\%$ $ \Delta \tan \delta  \le 0.005 (1 \text{ kHz})$ $R_{INS} \ge 50\%$ of initial limit

#### **Mounting guidelines**

#### 1 Soldering

# 1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/ $-0.5$ mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder $\geq$ 90%, free-flowing solder



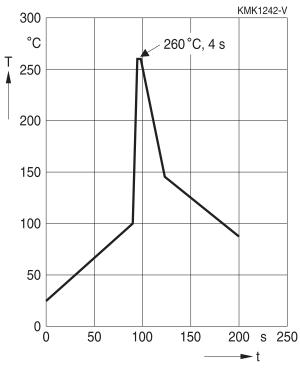


MKP DC Link - 125  $^{\circ}\text{C}$  series up to 50  $\mu\text{F}$ 

# 1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

Series	S	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP	· · · · · ·	-	
MKP	(lead spacing > 7.5 mm)		
MKT	boxed (case 2.5 $\times$ 6.5 $\times$ 7.2 mm)		5 ±1 s
MKP	(lead spacing $\leq$ 7.5 mm)		< 4 s
MKT	uncoated (lead spacing $\leq$ 10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated
			(lead spacing $\leq$ 10 mm) and insulated (B32559)



Immersion depth	2.0 +0/ $-0.5$ mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 $\pm 0.5$ ) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
tan δ	As specified in sectional specification

Please read *Cautions and warnings* and *Important notes* at the end of this document.



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MKP DC Link - 125 °C series up to 50  $\mu$ F

#### 1.3 General notes on soldering

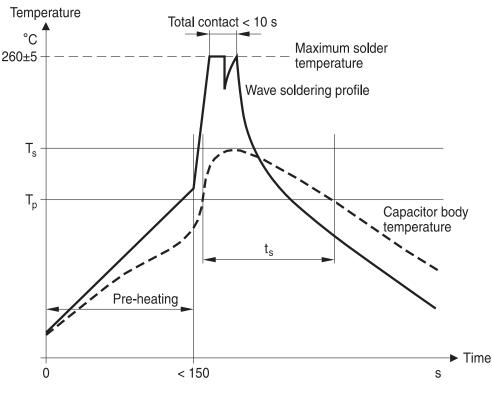
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{max}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
  - diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

#### **EPCOS** recommendations

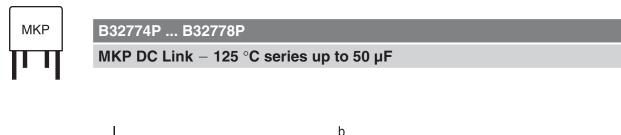
As a reference, the recommended wave soldering profile for our film capacitors is as follows:

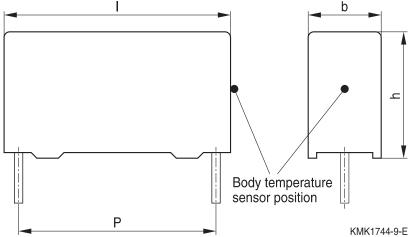


 $T_s$ : Capacitor body maximum temperature at wave soldering  $T_p$ : Capacitor body maximum temperature at pre-heating

KMK1745-A-E







Body temperature should follow the description below:

- MKP capacitor During pre-heating: T<sub>p</sub> ≤ 110 °C During soldering: T<sub>s</sub> ≤ 120 °C, t<sub>s</sub> ≤ 45 s
- MKT capacitor During pre-heating:  $T_p \le 125 \text{ °C}$ During soldering:  $T_s \le 160 \text{ °C}$ ,  $t_s \le 45 \text{ s}$

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T<sub>s</sub>) must be  $\leq$  120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <  $360 \degree C$  and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings  $\leq$  10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to EPCOS Film Capacitor Data Book in case more details are needed.



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MKP DC Link - 125  $^{\circ}\text{C}$  series up to 50  $\mu\text{F}$ 

#### **Cautions and warnings**

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Торіс	Safety information	Reference chapter
		"General technical
		information"
Storage	Make sure that capacitors are stored within the specified	4.5
conditions	range of time, temperature and humidity conditions.	"Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive	5.3
	flammability), avoid overload of the capacitors (active	"Flammability"
	flammability) and consider the flammability of materials.	
Resistance to	Do not exceed the tested ability to withstand vibration.	5.2
vibration	The capacitors are tested to IEC 60068-2-6.	"Resistance to
	EPCOS offers film capacitors specially designed for	vibration"
	operation under more severe vibration regimes such as	
	those found in automotive applications. Consult our	
	catalog "Film Capacitors for Automotive Electronics".	

Торіс	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"





# Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.

Detailed information can be found on the Internet under <u>www.epcos.com/orderingcodes</u>.



MKP DC Link - 125  $^\circ C$  series up to 50  $\mu F$ 

# MKP

# Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
$\alpha^{c}$	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β <sub>c</sub>	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C <sub>R</sub>	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative	Relative Kapazitätsänderung (relative
	deviation of actual value)	Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation	Kapazitätstoleranz (relative Abweichung
	from rated capacitance)	vom Nennwert)
dt	Time differential	Differentielle Zeit
$\Delta t$	Time interval	Zeitintervall
$\Delta T$	Absolute temperature change	Absolute Temperaturänderung
	(self-heating)	(Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
$\Delta V$	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate	Differentielle Spannungsänderung
	of voltage rise)	(Spannungsflankensteilheit)
$\Delta V / \Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f <sub>1</sub>	Frequency limit for reducing permissible	Grenzfrequenz für thermisch bedingte
	AC voltage due to thermal limits	Reduzierung der zulässigen
		Wechselspannung
f <sub>2</sub>	Frequency limit for reducing permissible	Grenzfrequenz für strombedingte
	AC voltage due to current limit	Reduzierung der zulässigen
		Wechselspannung
f <sub>r</sub>	Resonant frequency	Resonanzfrequenz
F <sub>D</sub>	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F <sub>τ</sub>	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
l <sub>c</sub>	Category current (max. continuous	Kategoriestrom (max. Dauerstrom)
	current)	



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MKP DC Link - 125  $^\circ C$  series up to 50  $\mu F$ 

Symbol	English	German
I <sub>RMS</sub>	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i <sub>z</sub>	Capacitance drift	Inkonstanz der Kapazität
k <sub>o</sub>	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λο	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
$\lambda_{ ext{test}}$	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P <sub>diss</sub>	Dissipated power	Abgegebene Verlustleistung
P <sub>gen</sub>	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
R <sub>i</sub>	Internal resistance	Innenwiderstand
R <sub>ins</sub>	Insulation resistance	Isolationswiderstand
R₽	Parallel resistance	Parallelwiderstand
Rs	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$\tan \delta_{D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ <sub>P</sub>	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
$\tan \delta_{s}$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T <sub>A</sub>	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T <sub>max</sub>	Upper category temperature	Obere Kategorietemperatur
T <sub>min</sub>	Lower category temperature	Untere Kategorietemperatur
t <sub>ol</sub>	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
T <sub>op</sub>	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
T <sub>R</sub>	Rated temperature	Nenntemperatur
T <sub>ref</sub>	Reference temperature	Referenztemperatur
t <sub>SL</sub>	Reference service life	Referenz-Lebensdauer



B32774P ... B32778P

MKP DC Link - 125  $^\circ C$  series up to 50  $\mu F$ 

Symbol	English	German
V <sub>AC</sub>	AC voltage	Wechselspannung
V <sub>c</sub>	Category voltage	Kategoriespannung
V <sub>C,RMS</sub>	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
$V_{CD}$	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
$V_{ch}$	Charging voltage	Ladespannung
$V_{\text{DC}}$	DC voltage	Gleichspannung
$V_{\text{FB}}$	Fly-back capacitor voltage	Spannung (Flyback)
Vi	Input voltage	Eingangsspannung
Vo	Output voltage	Ausgangssspannung
V <sub>op</sub>	Operating voltage	Betriebsspannung
V <sub>p</sub>	Peak pulse voltage	Impuls-Spitzenspannung
$V_{pp}$	Peak-to-peak voltage Impedance	Spannungshub
V <sub>R</sub>	Rated voltage	Nennspannung
Ŷ <sub>R</sub>	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V <sub>RMS</sub>	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
$V_{\text{SC}}$	S-correction voltage	Spannung bei Anwendung "S-correction"
$V_{sn}$	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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